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CONFIRMATION NO. 9500

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<b>APPLICANTS</b> Kiyoshi Ooi, Nagano-shi, JAPAN; Yasuyoshi Horikawa, Nagano-shi, JAPAN; Akio Rokugawa, Nagano-shi, JAPAN; <i>DM</i>				
<b>** CONTINUING DATA *****</b> <i>DM</i>				
<b>** FOREIGN APPLICATIONS *****</b> <i>DM</i> JAPAN 2003-104070 04/08/2003				
<b>IF REQUIRED, FOREIGN FILING LICENSE GRANTED</b> <b>** 06/08/2004</b>				
Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 (a-d) conditions <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after met <input checked="" type="checkbox"/> Allowance		<b>STATE OR COUNTRY</b> JAPAN	<b>SHEETS DRAWING</b> 12	<b>TOTAL CLAIMS</b> 23
Verified and Acknowledged Examiner's Signature <i>[Signature]</i> Initials <i>DM</i>		<b>INDEPENDENT CLAIMS</b> 5		
<b>ADDRESS</b> 26530				
<b>TITLE</b> Semiconductor device substrate, semiconductor device, and manufacturing method thereof				
<b>FILING FEE RECEIVED</b> 996	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue ) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit	